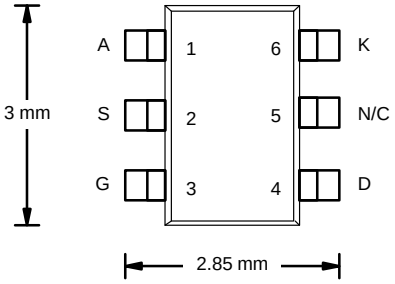
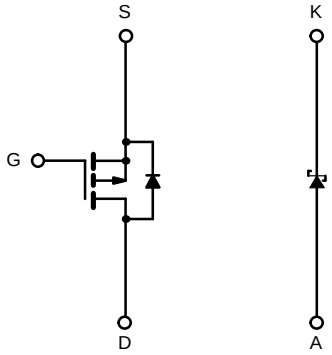
P-Channel 30-V (D-S) MOSFET With Schottky Diode

MOSFET PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
–30	0.200 @ V_{GS} = –10 V	±1.8
	0.360 @ V_{GS} = –4.5 V	±1.2

SCHOTTKY PRODUCT SUMMARY		
V_{KA} (V)	V_f (v) Diode Forward Voltage	I_F (A)
30	0.5 V @ 0.5 A	0.5

LITTLE FOOT Plus™





P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C UNLESS OTHERWISE NOTED)					
Parameter		Symbol	5 sec	Steady State	Unit
Drain-Source Voltage (MOSFET and Schottky)		V_{DS}	–30		V
Reverse Voltage (Schottky)		V_{KA}	30		
Gate-Source Voltage (MOSFET)		V_{GS}	±20	±20	
Continuous Drain Current (T_J = 150°C) (MOSFET)[a]	T_A = 25°C	I_D	±1.8	±1.6	A
	T_A = 70°C		±1.5	±1.2	
Pulsed Drain Current (MOSFET)		I_{DM}	±7		
Continuous Source Current (MOSFET Diode Conduction)[a]		I_S	–1.05	–0.75	
Average Foward Current (Schottky)		I_F	0.5		
Pulsed Foward Current (Schottky)		I_{FM}	7		
Maximum Power Dissipation (MOSFET)[a]	T_A = 25°C	P_D	1.15	0.83	W
	T_A = 70°C		0.73	0.53	
Maximum Power Dissipation (Schottky)[a]	T_A = 25°C		1.0	0.76	
	T_A = 70°C		0.64	0.48	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	–55 to 150		°C

Notes
a. Surface Mounted on 1" x 1" FR4 Board.

THERMAL RESISTANCE RATINGS

Parameter		Device	Symbol	Typical	Maximum	Unit
Junction-to-Ambient	t ≤ 5 sec	MOSFET	R_{thJA}	93	110	°C/W
		Schottky		103	125	
	Steady State	MOSFET		130	150	
		Schottky		140	165	
Junction-to-Foot	Steady State	MOSFET	R_{thJF}	75	90	
		Schottky		80	95	

Notes
a. Surface Mounted on 1" x 1" FR4 Board.

MOSFET SPECIFICATIONS (T_J = 25°C UNLESS OTHERWISE NOTED)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = –250 µA	–1.0			V
Gate-Body Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ±20 V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = –24 V, V_{GS} = 0 V			–1	µA
		V_{DS} = –24 V, V_{GS} = 0 V, T_J = 75°C			–10	
On-State Drain Current[a]	$I_{D(on)}$	V_{DS} ≥ –5 V, V_{GS} = –10 V	–5			A
Drain-Source On-State Resistance[a]	$r_{DS(on)}$	V_{GS} = –10 V, I_D = –1.8 A		0.165	0.200	Ω
		V_{GS} = –4.5 V, I_D = –1.2 A		0.298	0.360	
Forward Transconductance[a]	g_{fs}	V_{DS} = –15 V, I_D = –1.8 A		2.4		S
Diode Forward Voltage[a]	V_{SD}	I_S = –1.05 A, V_{GS} = 0 V		–0.83	–1.10	V
Dynamic[b]						
Total Gate Charge	Q_g	V_{DS} = –15 V, V_{GS} = –5 V, I_D = –1.8 A		2.4	3.6	nC
Gate-Source Charge	Q_{gs}			0.9		
Gate-Drain Charge	Q_{gd}			0.8		
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = –15 V, R_L = 15 Ω I_D ≅ –1 A, V_{GEN} = –10 V, R_G = 6 Ω		8	12	ns
Rise Time	t_r			12	18	
Turn-Off Delay Time	$t_{d(off)}$			12	18	
Fall Time	t_f			7	11	
Source-Drain Reverse Recovery Time	t_{rr}	I_F = –1.05 A, di/dt = 100 A/µs		30	60	

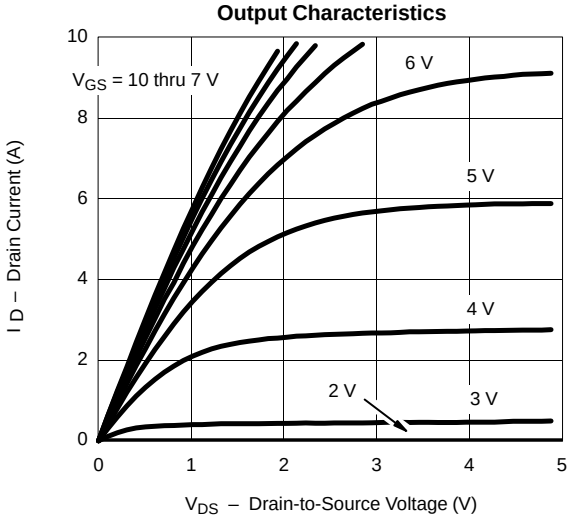
Notes
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2%.
b. Guaranteed by design, not subject to production testing.

SCHOTTKY SPECIFICATIONS (T_J = 25°C UNLESS OTHERWISE NOTED)

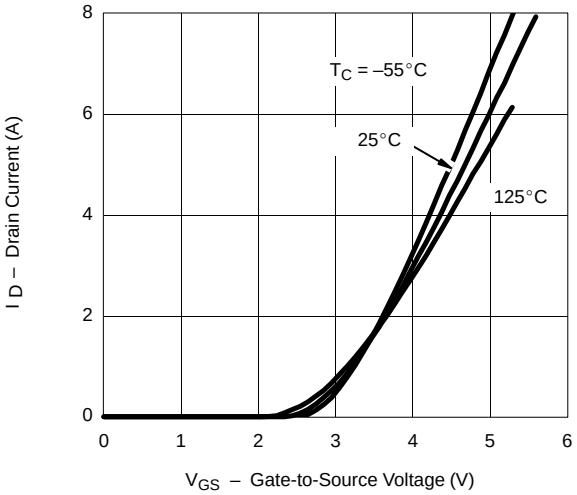
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Forward Voltage Drop	V_F	I_F = 0.5 A		0.45	0.5	V
		I_F = 0.5 A, T_J = 125°C		0.35	0.4	
Maximum Reverse Leakage Current	I_{rm}	V_r = 30 V		0.002	0.100	mA
		V_r = 30 V, T_J = 75°C		0.06	1	
		V_r = 30 V, T_J = 125°C		1.5	10	
Junction Capacitance	C_T	V_r = 10 V		24		pF

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED) MOSFET

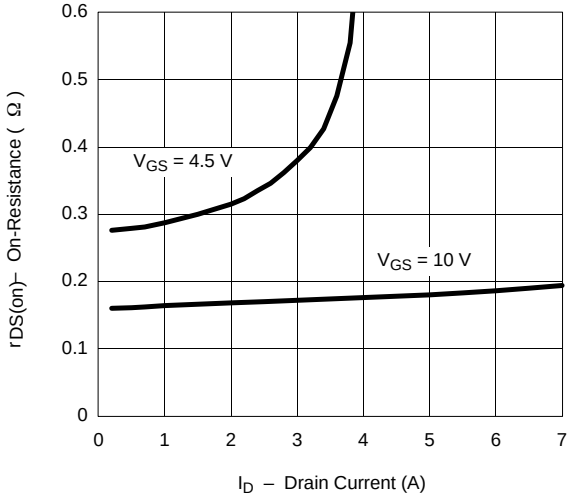
Output Characteristics



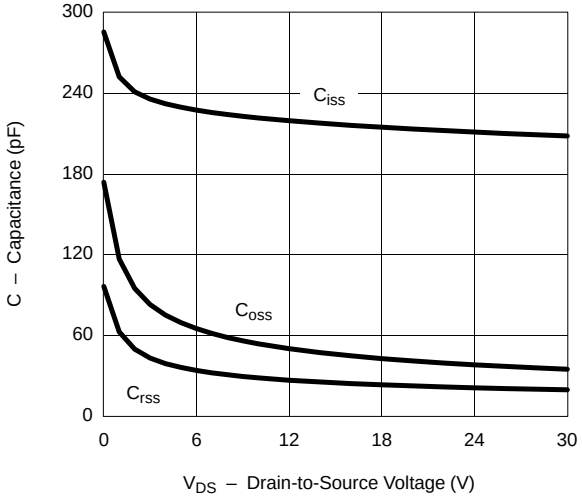
Transfer Characteristics



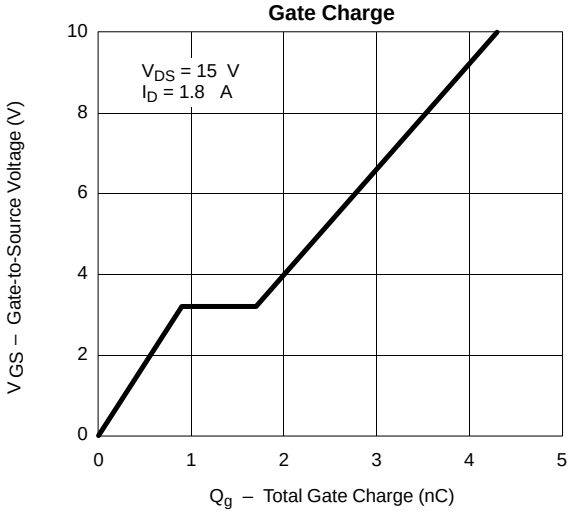
On-Resistance vs. Drain Current



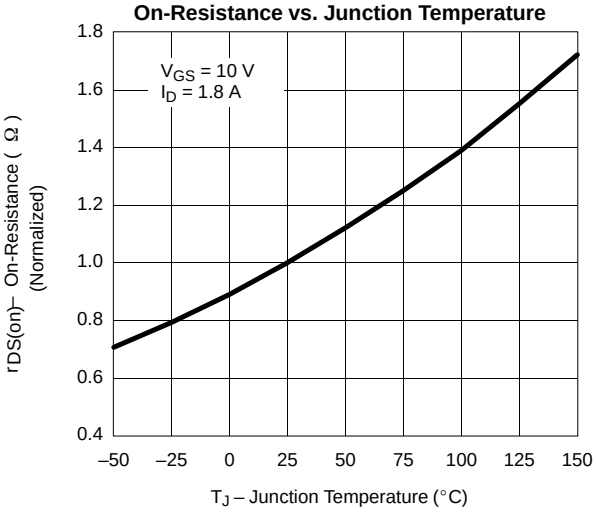
Capacitance



Gate Charge

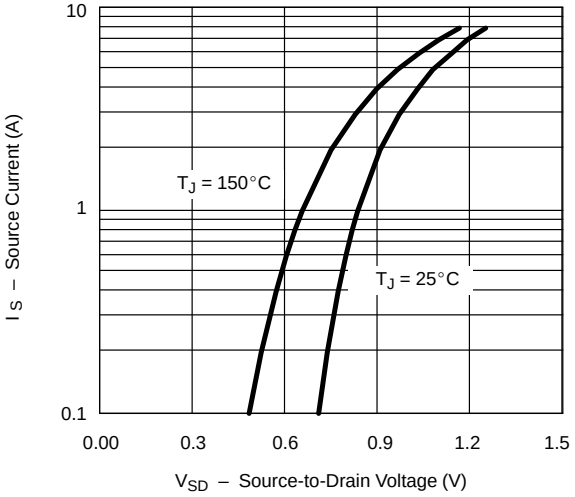


On-Resistance vs. Junction Temperature

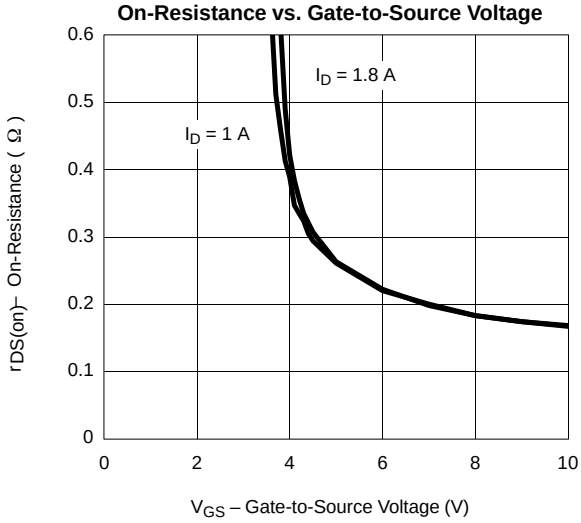


TYPICAL CHARACTERISTICS (25°C UNLESS NOTED) MOSFET

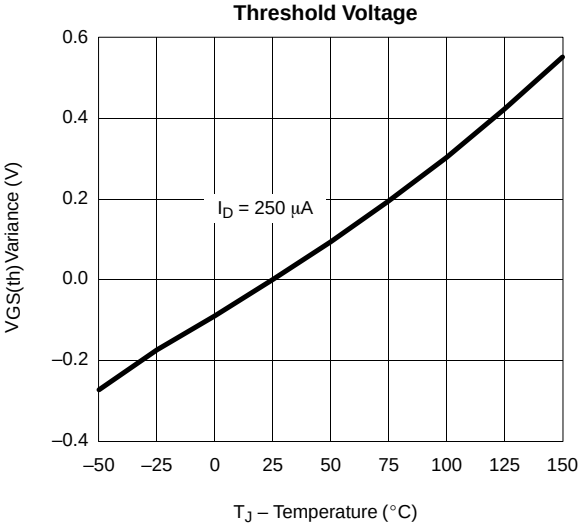
Source-Drain Diode Forward Voltage



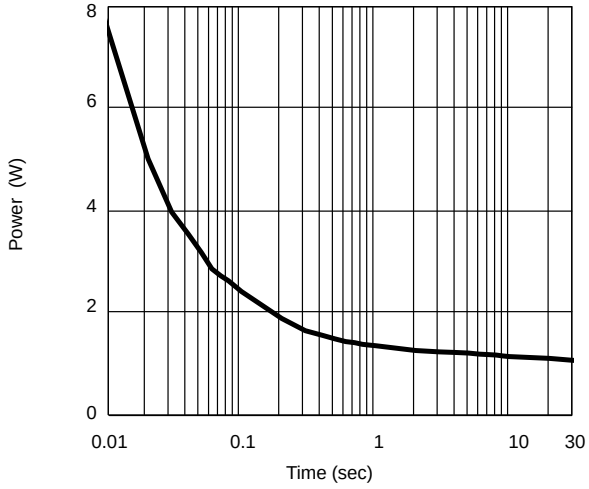
On-Resistance vs. Gate-to-Source Voltage



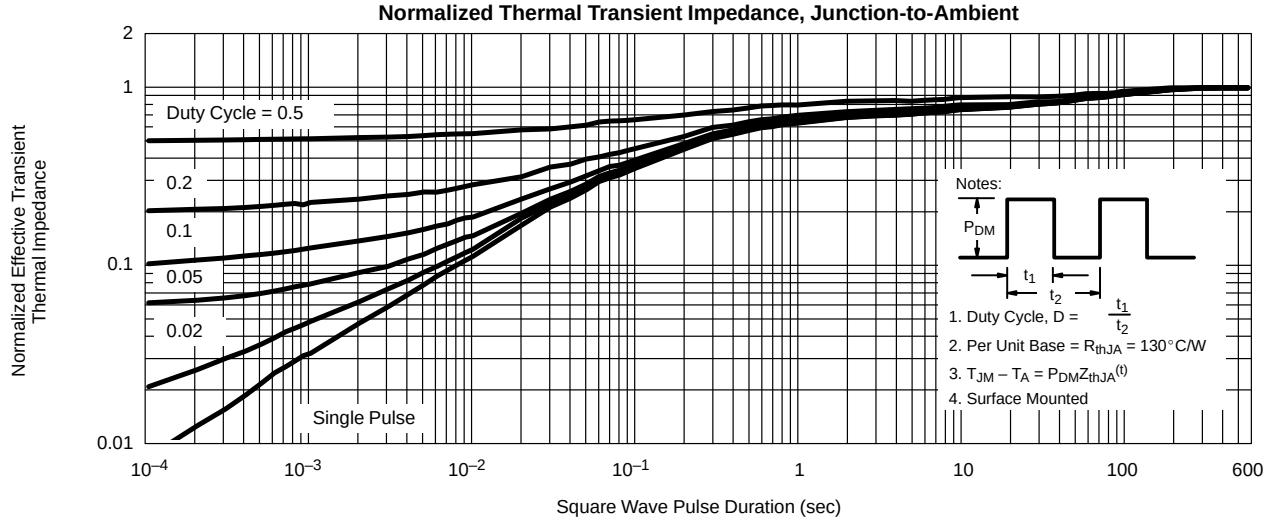
Threshold Voltage



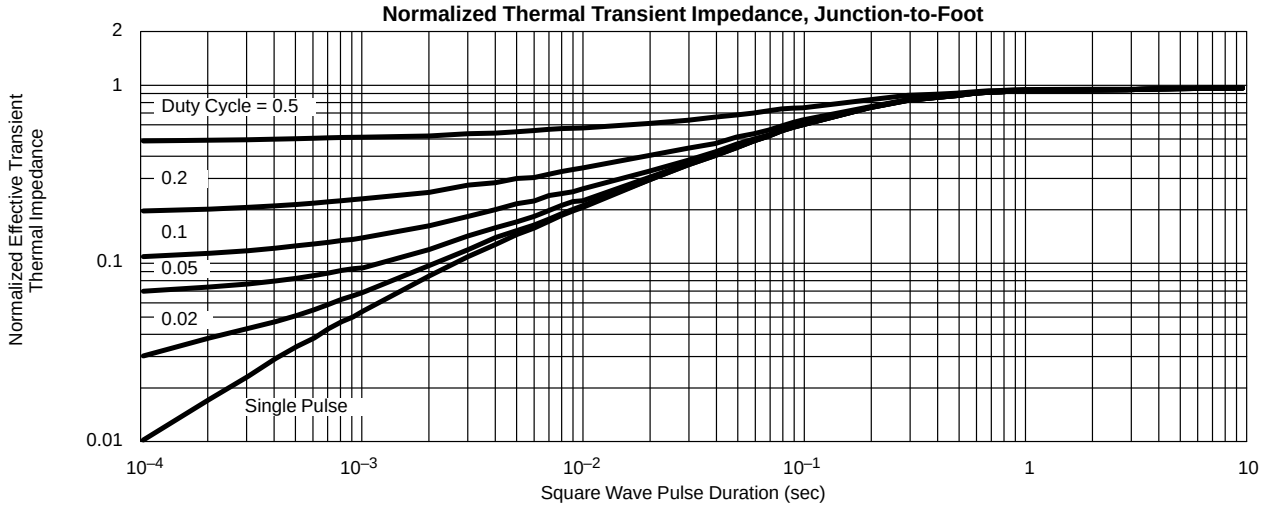
Single Pulse Power, Junction-to-Ambient



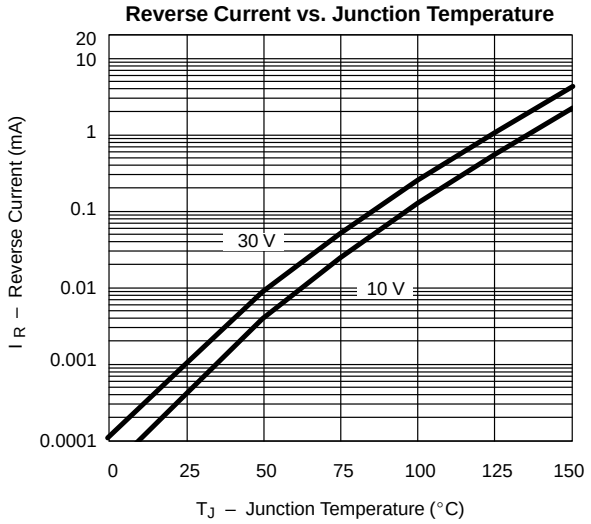
Normalized Thermal Transient Impedance, Junction-to-Ambient

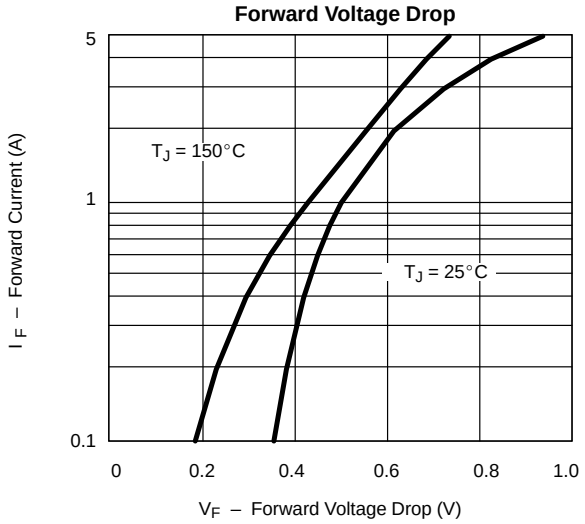


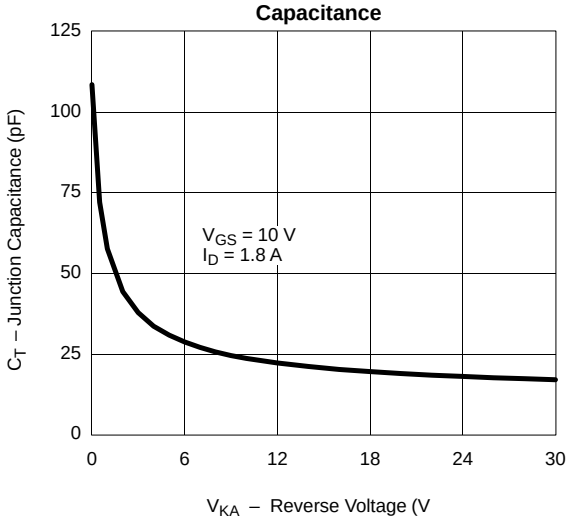
TYPICAL CHARACTERISTICS (25°C UNLESS NOTED) MOSFET



TYPICAL CHARACTERISTICS (25°C UNLESS NOTED) SCHOTTKY

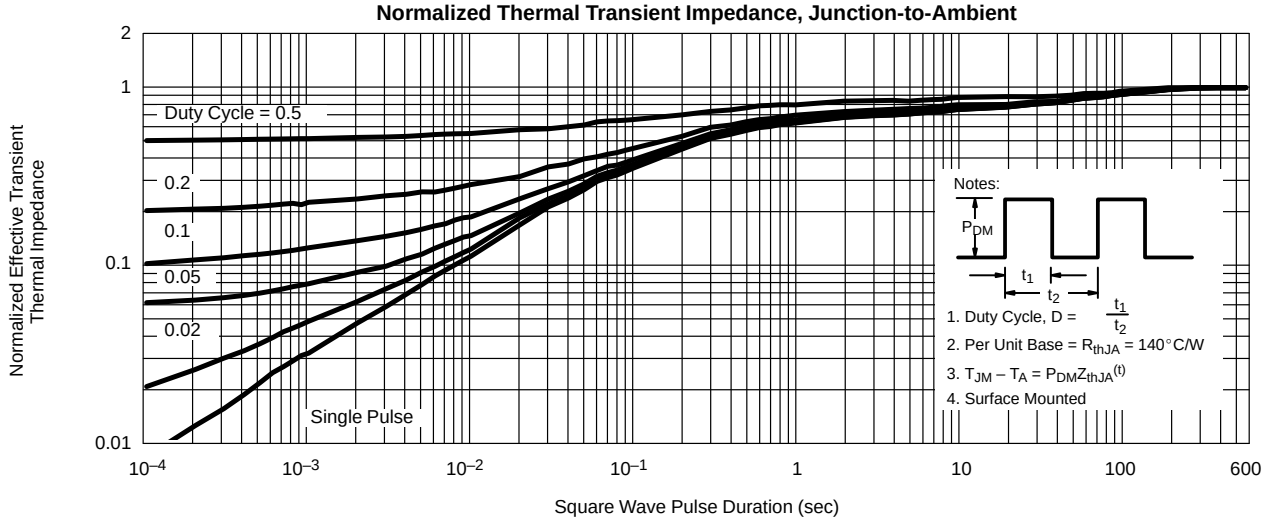




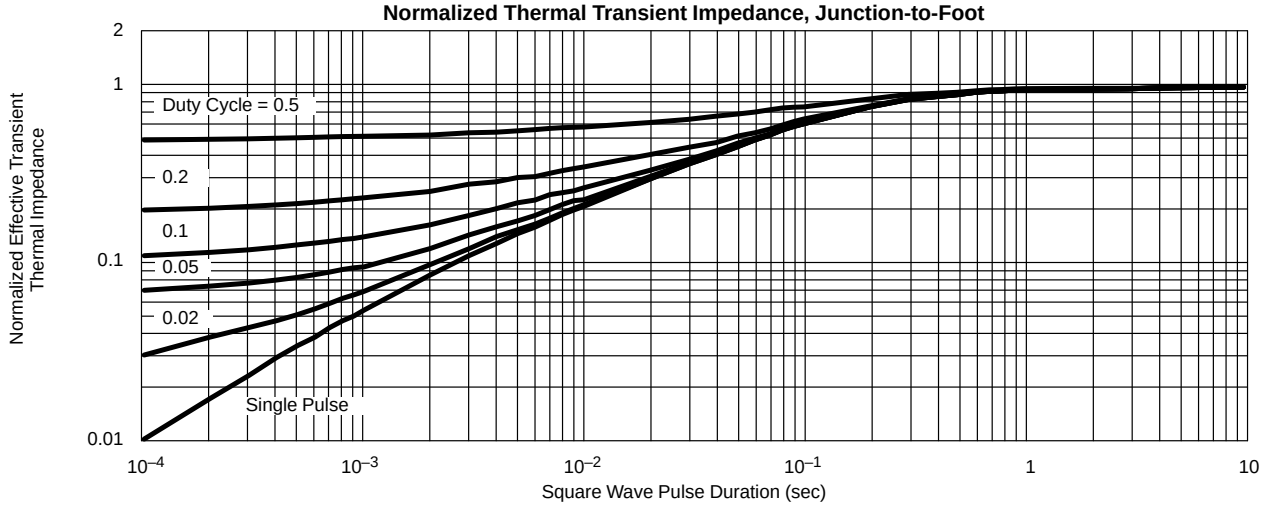


TYPICAL CHARACTERISTICS (25°C UNLESS NOTED) SCHOTTKY

Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



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